

ASX RELEASE

7 December 2022

2023 IMEC COLLABORATION UPDATE

4DS Memory Limited (ASX:4DS) (**4DS** or the **Company**) is pleased to provide an update on the 2023 imec collaboration extension and the planned manufacturing of the Fourth Platform Lot wafers.

2023 imec collaboration extension

4DS and imec have now finalised the terms of the 2023 collaboration extension which will now run to mid-2023.

4DS and imec have agreed to additional collaboration activities to be undertaken during the rest of 2022 and first half of 2023. The consideration for all collaboration activities is 903k Euro.

imec manufacture of Fourth Platform Lot

Process optimization and short loop analysis will take place over the balance of 2022 and the first few months of 2023.

Manufacturing of the Fourth Platform Lot will commence during Q1 2023 with the delivery to 4DS expected at the end of Q2 2023.

4DS' Executive Chairman, Drs. Wilbert van den Hoek "We are extremely pleased to have reached agreement with imec for an extension of our collaboration into 2023. We will continue to undertake internal activities, the results of which will be inputs to the collaboration during 2023. Furthermore, we are continually improving our testing capability to ensure that we are best placed for a potentially successful outcome."

4DS Interactive Investor Hub

If you have any questions on this announcement or any past 4DS announcements, check out our Investor Hub. Like, comment, ask a question and view video summaries on important announcements. Shareholders can link through to the Investor Hub via: announcements.4dsmemory.com

Authorised for release by the Board.

ENDS

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About 4DS

4DS Memory Limited (ASX: 4DS), with facilities located in Silicon Valley, is a semiconductor development company of non-volatile memory technology, pioneering Interface Switching ReRAM for next generation gigabyte storage in mobile and cloud. Established in 2007, 4DS owns a patented IP portfolio, comprising 33 USA patents granted and 1 patent application, which has been developed in-house to create high-density Storage Class Memory. 4DS has a joint development agreement with Western Digital subsidiary HGST, a global storage leader, which accelerates the evolution of 4DS' technology. 4DS also collaborates with imec, a world-leading research and innovation hub in

nanoelectronics and digital technologies. The combination of imec's widely acclaimed leadership in microchip technology and profound software and information and communication technology expertise makes them unique.

For more information, please visit www.4dsmemory.com.

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